

Hewlett-Packard Company  
Intellectual Property Administration  
P. O. Box 272400  
Fort Collins, Colorado 80527-2400

PATENT APPLICATION

ATTORNEY DOCKET NO. 100153804

IN THE  
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Shen Buswell

Confirmation No.: 3576

Application No.: 10/642,872

Examiner: Anita Kares Alanko

Filing Date: 8/18/2003

Group Art Unit: 1765

Title: Slotted Substrate and Method of Making

Mail Stop  
Commissioner For Patents  
PO Box 1450  
Alexandria, VA 22313-1450

TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

Sir:

Transmitted herewith is/are the following in the above-identified application:

- (X) Response/Amendment ( ) Petition to extend time to respond  
( ) New fee as calculated below ( ) Supplemental Declaration  
(X) No additional fee  
( ) Other: \_\_\_\_\_ (fee \$ \_\_\_\_\_)

CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY						
(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	(4) HIGHEST NUMBER PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEES
TOTAL CLAIMS		MINUS		=	X 50	\$
INDEP. CLAIMS		MINUS		=	X 200	\$
[ ] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM					+	\$
EXTENSION FEE	1ST MONTH	2ND MONTH	3RD MONTH	4TH MONTH		\$
OTHER FEES						\$
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$

Charge \$ 0.00 to Deposit Account 08-2025. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 08-2025 under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

(X) I hereby certify that this paper is being transmitted  
to the Patent and Trademark Office facsimile  
number (703) 872-9306 on 02-24-2005  
Number of pages:

Typed Name: Carlin Taylor

Signature: 

By 

Paul W. Mitchell

Attorney/Agent for Applicant(s)  
Reg. No. 44453

Date: 02-24-2005

Rev 12/04 (TAAndFee)

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- Attach as First Page to Transmitted Papers -

IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE

Inventors: Buswell et al. Examiner: Alanko, A  
5 Serial No: 10/642,872 Group Art Unit: 1765  
Filing Date: 8/18/03 Confirmation No: 3676  
Title: Slotted Substrate and Method of Making

To: Commissioner of Patents and Trademarks  
10 PO Box 1450  
Alexandria, VA 22313-1450

From: Hewlett-Packard Development Company, L.P.  
Intellectual Property Administration  
15 P.O. Box 272400  
Fort Collins, Colorado 80527-2400

INTRODUCTORY COMMENTS

This communication is in response to the Office Action dated 12/14/04,  
20 for which a three-month shortened statutory period for response is set for  
03/14/05. Please amend the above-identified application in accordance with the  
directions set forth below.

Amendments to the Claims are reflected on the list of claims which  
begins on page 2 of this communication.

25 Remarks/Arguments begin on page 9 of this communication.